

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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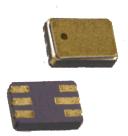


2N4854U (TX, TXV)

Electronics

Features:

- Ceramic 6 pin surface mount package
- Small package to minimize circuit board area
- Hermetically sealed
- Processed per MIL-PRF-19500/421



Description:

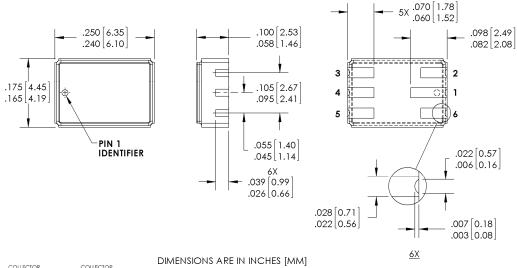
The 2N4854U (TX, TXV) are hermetically sealed, ceramic surface mount complementary NPN/PNP transistor pair. The "U" suffix denotes the six terminal (C-6) leadless chip carrier package option. The miniature six pin ceramic package is ideal for designs where board space and device weight are important design considerations.

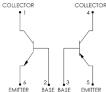
Typical screening and lot acceptance tests are per MIL-PRF-19500/421. The burn-in condition is $V_{CB} = 30 \text{ V}$, $P_D = 300 \text{ mW}$ each transistor, $T_A = 25^{\circ}\text{C}$. Refer to MIL-PRF-19500/421 for complete requirements.

When ordering parts without processing, do not us the TX or TXV suffix.

Applications:

- General switching
- Amplification
- Signal processing
- Radio transmission
- Logic gates





 Pin #
 PNP Transistor
 Pin #
 NPN

 3
 Base
 2
 Base

 4
 Collector
 1
 Collector

 5
 Emitter
 6
 Emitter



2N4854U (TX, TXV)

Electrical Specifications

Absolute Maximum Ratings (T _A = 25° C unless otherwise noted.) See Note 3	
NPN to PNP Isolation Voltage	500 VDC
Collector-Base Voltage	60 V
Collector-Emitter Voltage	40 V
Emitter-Base Voltage	5.0 V
Collector Current-Continuous	600 mA
Operating Junction Temperature (T _J)	-65° C to +200 °C
Storage Junction Temperature (T _{stg})	-65° C to +200° C
Power Dissipation @ $T_A = 25$ °C (both transistors driven equally)	0.6 W
Power Dissipation @ Tc = 25° C (both transistors driven equally)	2.0 W ⁽¹⁾
Soldering Temperature (vapor phase reflow for 30 seconds)	215° C
Soldering Temperature (heated collet for 5 seconds)	260° C

SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITIONS
OFF CHAR	ACTERISTICS	ı			
V _{(BR)CBO}	Collector-Base Breakdown Voltage	60		V	$I_C = 10 \mu A, I_E = 0$
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	40		V	$I_C = 10 \text{ mA}, I_B = 0^{(2)}$
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	5		V	$I_E = 10 \mu A, I_C = 0$
I _{CBO}	Collector-Base Cutoff Current		10	nA	$V_{CB} = 50 \text{ V}, I_{E} = 0$
			10	μΑ	$V_{CB} = 50 \text{ V}, I_E = 0, T_A = 150^{\circ} \text{ C}$
I _{EBO}	Emitter-Base Cutoff Current		10	nA	$V_{EB} = 3 \text{ V, } I_{C} = 0$
ON CHAR	ACTERISTICS				
h _{FE}	Forward-Current Transfer Ratio	50		-	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}^{(2)}$
		35		-	$V_{CE} = 10 \text{ V}, I_{C} = 0.1 \text{ mA}$
		50		-	$V_{CE} = 10 \text{ V}, I_{C} = 1.0 \text{ mA}$
		75		-	$V_{CE} = 10 \text{ V, } I_{C} = 10 \text{ mA}^{(2)}$
		100	300	-	$V_{CE} = 10 \text{ V, } I_{C} = 150 \text{ mA}^{(2)}$
		35		-	$V_{CE} = 10 \text{ V, } I_{C} = 300 \text{ mA}^{(2)}$
		12		-	$V_{CE} = 10 \text{ V}, I_{C} = 10 \text{ mA}, T_{A} = -5$

Note: 1. Derate linearly 6.6 mW/°C above 25° C

2. Pulse Width ≤300 μs, Duty Cycle ≤ 2.0%

3. Polarities given are for the NPN device. Reverse polarity on limits & conditions as applicable for the PNP side.



2N4854U (TX, TXV)

Electrical Characteristics (T _A = 25° C unless otherwise noted)								
SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITIONS			
ON CHARA	ACTERISTICS							
V _{CE (SAT)}	Collector-Emitter Saturation Voltage		0.40	V	I _C = 150 mA, I _B = 15 mA ⁽²⁾			
$V_{BE(SAT)}$	Base-Emitter Saturation Voltage	0.8		V	I _C = 150 mA, I _B = 15 mA ⁽²⁾			
SMALL-SIG	GNAL CHARACTERISTICS							
h _{ie}	Small Signal Common Emitter Input Impedance	1.5	9	kΩ				
h _{oe}	Small Signal Common Emitter Output Admittance		50	μmho	V _{CE} = 10 V, I _C = 1.0 mA, f = 1.0 kHZ			
h _{fe}	Small Signal Current Transfer Ratio	60	300	-				
NF	Noise Figure		8	db	$f = 1.0 \text{ kHZ}$, $R_G = 1.0 \text{ k}\Omega$, $I_C = 0.1 \text{ mA}$, $V_{CE} = 10 \text{ V}$			
h _{fe}	Small Signal Forward Current Transfer Ratio	2	8	-	V _{CE} = 20 V, I _C = 20 mA, f = 100 MHz			
C _{obo}	Open Circuit Output Capacitance		8	pF	$V_{CB} = 10 \text{ V}, 100 \text{ kHz} \le f \le 1.0 \text{ MHZ}$			
SWITCHIN	G CHARACTERISTICS							
t_{on}	Turn-On Time		45	ns	V _{CC} = 30 V, I _C = 150 mA, I _{B1} = 15 mA			
t _{off}	Turn-Off Time		300	ns	$V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA}, I_{B1} = I_{B2} = 15 \text{ mA}$			

Note: 1. Derate linearly 6.6 mW/°C above 25° C 2. Pulse Width ≤300 µs, Duty Cycle ≤ 2.0% 3. Polarities given are for the NPN device. Reverse polarity on limits & conditions as applicable for the PNP side.





Standard Packaging:

